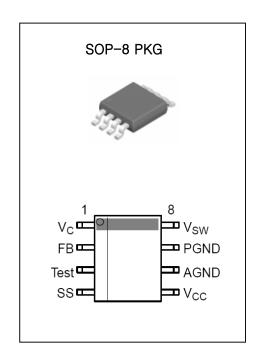
FEATURES

- Intergrated Power Switch 1.5A Guaranteed
- Wide Input Voltage Range 2.7V to 30V
- High Frequency Allows for Small Components
- Minimum External Components
- Easy External Synchronization
- Frequency Foldback Reduces Component Stress During an Overcurrent Condition
- Thermal Shutdown with Hysteresis
- Shut Down Current is 50 uA Maximum
- Wide Ambient Temperature Range Commercial Grade : 0°C to 70°C
- Moisture Sensitivity Level 3



ORDERING INFORMATION

Device	Marking	Package
LM5171D	LM5171	SOP-8

APPLICATION

- LCD Monitor/TV LED Backlight Driver.
- TFT-LCD Power Management

DESCRIPTION

The LM5171 product is 280 kHz switching regulator with a high efficiency, 1.5A intergrated switch. This part operate over a wide input voltage range, from 2.7V to 30V. The flexibility of the design allows the chip to operate in most power supply configurations, including boost, flyback, forward, invering, and SEPIC. This Ics utilize current mode architecture, which allows excellent load and line regulatuon, as well as a practical means for limiting current. Combining high frequency operation with a highly integrated regulator circuit results in an extremely compact power supply solution. The circuit design include provisions for features such as frequency synchronization, shutdown, and feedback control.

Figure 1. Application Circuit

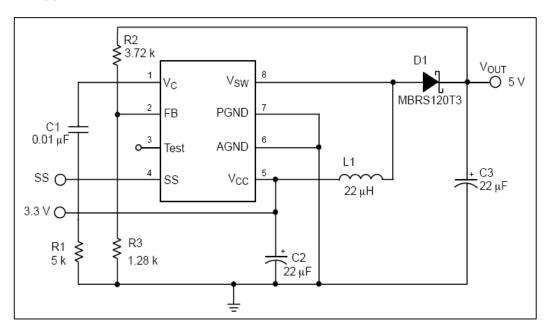
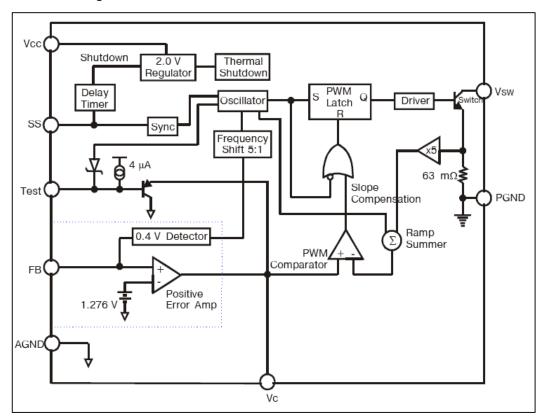


Figure 2. Block Diagram



ABSOLUTE MAXIMUM RATINGS

(Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Maximum ratings applied to the device are individule stress limit value and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damaged may occur and reliability may be affected.

Rating	Symbol	Value	Unit
Junction Temperature Range	T_J	0 to125	°C
Storage Temperature Range	Tstg	-65 to +150	°C
Thermal Resistance, Juntion to Ambient	Reja	165	°C/W
Thermal Resistance, Juntion to Case	Rejc	45	°C/W
Minimum ESD Rating		1.0	kV
(Human Body Model :C=100 pF, R=1.5kΩ)	_	1.2	
Lead Temperature Soldering : Reflow (Note 1)	-	230	c

Note 1. 60 second maximum above 183℃

ABSOLUTE MAXIMUM RATINGS

(Operating Ratings indicate conditions for which the device is intended to be but do not guarantee specific performance limits. For guaranteed specifications, see the Electrical Characteristics.)

Pin Name	Pin Symbol	V_{MAX}	V_{MIN}	I _{SOURCE}	I _{SINK}
IC Power Input	Vcc	30 V	- 0.3 V	N / A	200 mA
Shutdown / Sync	SS	30 V	- 0.3 V	1.0 mA	1.0 mA
Loop Compensation	Vc	6.0 V	- 0.3 V	10 mA	10 mA
Voltage Feedback Input	FB	10 V	- 0.3 V	1.0 mA	1.0 mA
Test Pin	Test	6.0 V	- 0.3 V	1.0 mA	1.0 mA
Power Ground	PGND	0.3 V	- 0.3 V	4.0 A	1.0 mA
Analog Ground	AGND	0 V	0 V	N / A	10 mA
Switch Input	Vsw	40 V	- 0.3 V	10 mA	3.0 A

ELECTRICAL CHARACTERISTICS (2.7V < Vcc < 30 V, 0° C < T_J < 125 $^{\circ}$ C, unless otherwise stated.)

Frequency Shift Threshold Frequency Drops to reduced operating frequency 0.36 0.40 0.44 V	Characteristics	Test Condition	Min	TYP	Max	Unit	
FB Reference Voltage	· · · · · · · · · · · · · · · · · · ·						
FB Input Voltage		Vc tied to FB: Measure at FB	1 246	1 276	1 300	V	
FB Reference Voltage Line Regulati							
Error Amp Transconductance			_				
Section Note 2 200 500 − V/V			300				
Vc Source current FB = 1.0V, Vc = 1.25V 25 50 90					-		
Vc Sink Current FB = 1.5V, Vc = 1.25V 200 625 1500 uA Vc High Clamp Voltage FB = 1.0V, Vc sources 25uA 1.5 1.7 1.9 V Vc Low Clamp Voltage FB = 1.5V, Vc sinks 25uA 0.25 0.50 0.65 V Vc Threshold Reduce Vc from 1.5V until switching stops 200 625 1500 uA Oscillator Basse Operating Frequency FB = 1V 230 280 310 kHz Reduced Operating Frequency FB = 0V 30 52 120 kHz Maximum Duty Cycle Frequency Drops to reduced operating frequency 0.36 0.40 0.44 V Sprequency Shift Threshold Frequency Drops to reduced operating frequency 0.36 0.40 0.44 V Sync J Shutdown Sync Pulse Transition Threshold Rise Time = 20 ns 2.5 - V SS = 3.0V -15 -3 - V Shutdown Threshold Sign To = 1.5 -3 -					90		
Vc High Clamp Voltage FB = 1.0V, Vc sources 25uA 1.5 1.7 1.9 V Vc Low Clamp Voltage FB = 1.5V, Vc sinks 25uA 0.25 0.50 0.65 V Vc Threshold Reduce Vc from 1.5V until switching stops 200 625 1500 uA Oscillator Base Operating Frequency FB = 1V 230 280 310 kHz Reduced Operating Frequency FB = 0V 30 52 120 kHz Maximum Duty Cycle FB = 9V 30 52 120 kHz Maximum Duty Cycle Frequency Drops to reduced operating frequency 0.36 0.40 0.44 V Sync Pluse Transition Threshold Rise Time = 20 ns 2.5 - - V SS Fias Current SS = 0V -15 -3 - V Shutdown Threshold 2.7V ≤ Vcc ≤ 12V 12 80 350 us Shutdown Threshold 2.7V ≤ Vcc ≤ 12V 12 80 350 us							
Voc Low Clamp Voltage FB = 1.5V, Vc sinks 25uA 0.25 0.50 0.65 V Vc Threshold Reduce Vc from 1.5V until switching stops 200 625 1500 uA Oscillator Base Operating Frequency FB = 1V 230 280 310 kHz Reduced Operating Frequency FB = 0V 30 52 120 kHz Maximum Duty Cycle 90 94 - % FB Frequency Shift Threshold Frequency Drops to reduced operating frequency 90 94 - % FB Frequency Shift Threshold Frequency Drops to reduced operating frequency 90 94 - % Sync Pulse Transition Threshold Rise Time = 20 ns 2.5 - - V Sync Pulse Transition Threshold Rise Time = 20 ns 2.5 - - V SS Bias Current SS = 0V -15 -3 - uA Shutdown Threshold 85 = 0V -15 -3 - uA Shutdown Threshold 2.7V ≤ Vcc ≤ 12V 12 80 350 us Shutdown Delay 2.7V ≤ Vcc ≤ 30V 12 36 200 us Power Switch		·					
Vc Threshold Reduce Vc Irom 1.5V until switching stops 200 625 1500 uA Oscillator Base Operating Frequency FB = 1V 230 280 310 kHz Reduced Operating Frequency FB = 0V 30 52 120 kHz Maximum Duty Cycle Frequency Drops to reduced operating frequency 0.36 0.40 0.44 V FB Frequency Shift Threshold Frequency Drops to reduced operating frequency 0.36 0.40 0.44 V Sync P Abutdown Sync Palse Transition Threshold Rise Time = 20 ns 2.5 - - V Sync Pulse Transition Threshold Rise Time = 20 ns 2.5 - - V SS Bias Current SS = 3.0V - 3 8 uA Shutdown Threshold 2.7V ≤ Vcc ≤ 12V 12 80 350 us Shutdown Delay 2.7V ≤ Vcc ≤ 12V 12 80 350 us Power Switch Iswitch = 1.5A, Note 2 - 0.85 1.4		·					
Switching stops Oscillator Base Operating Frequency FB = 1V 230 280 310 kHz Reduced Operating Frequency FB = 0V 30 52 120 kHz Maximum Duty Cycle 90 94 - % FB Frequency Shift Threshold Frequency Drops to reduced operating frequency 0.36 0.40 0.44 V Sync / Shutdown Sync / Shutdown Sync Pluse Transition Threshold Rise Time = 20 ns 2.5 - - V SS Bias Current SS = 0V -15 -3 - uA Shutdown Threshold SS = 3.0V - 3 8 Shutdown Threshold 0.50 0.85 1.20 V Shutdown Delay 15 1.20 0.85						пΛ	
Base Operating Frequency FB = 1V 230 280 310 kHz Reduced Operating Frequency FB = 0V 30 52 120 kHz Maximum Duty Cycle 90 94 - % FB Frequency Shift Threshold Frequency Drops to reduced operating frequency 0.36 0.40 0.44 V Sync Puts Fransition Threshold Rise Time = 20 ns 2.5 - - V SS Bias Current SS = 0V -15 -3 - V SS Bias Current SS = 3.0V - 3 8 uA Shutdown Threshold 2.7V ≤ Vcc ≤ 12V 12 80 350 us Shutdown Threshold 0.50 0.85 1.20 V Shutdown Threshold 0.50 0.85 1.20 V Shutdown Threshold 0.50 0.85 1.20 V Shutdown Threshold 2.7V ≤ Vcc ≤ 12V 12 80 350 us Shutdown Threshold Issum Thr	ve miesnoid	switching stops	200	023	1300	u_	
Reduced Operating Frequency FB = 0V 30 52 120 kHz Maximum Duty Cycle 90 94 - % FB Frequency Shift Threshold Frequency Drops to reduced operating frequency 0.36 0.40 0.44 V Sync Pshutdown Sync Range 320 - 500 kHz Sync Pulse Transition Threshold Rise Time = 20 ns 2.5 - - V SS Bias Current SS = 3.0V - 3 8 uA Shutdown Threshold 0.50 0.85 1.20 V Shutdown Threshold 0.50 0.85 1.20 V Shutdown Delay 2.7V ≤ Vcc ≤ 12V 12 80 350 us Power Switch Iswitch = 1.5A, Note 2 1 0.85 1.4 V Switch Saturation Voltage Iswitch = 1.5A, Note 2 - 0.85 1.4 V Switch Current Limit 50% duty cycle, Note 2 1.6 1.9 2.4	Oscillator			ı	ı		
Maximum Duty Cycle Frequency Drops to reduced operating frequency 90 94 − % FB Frequency Shift Threshold Frequency Drops to reduced operating frequency 0.36 0.40 0.44 V Sync Pulse Transition Threshold Rise Time = 20 ns 2.5 − − V SS Bias Current SS = 0V −15 −3 − uA Shutdown Threshold 0.50 0.85 1.20 V Shutdown Threshold 0.50 0.85 1.20 V Shutdown Delay 2.7V ≤ Vcc ≤ 12V 12 80 350 us Power Switch Iswitch = 1.5A, Note 2 − 0.8 1.4 V Iswitch = 1.5A, Note 2 − 0.8 1.4 V Iswitch = 1.5A, Note 2 − 0.8 1.4 V Iswitch = 1.5A, Note 2 − 0.8 1.4 V Iswitch = 1.5A, Note 2 1.6 1.9 2.4 <t< td=""><td>Base Operating Frequency</td><td>FB = 1V</td><td>230</td><td>280</td><td>310</td><td>kHz</td></t<>	Base Operating Frequency	FB = 1V	230	280	310	kHz	
Frequency Shift Threshold Frequency Drops to reduced operating frequency 0.36 0.40 0.44 V	Reduced Operating Frequency	FB = 0V	30	52	120	kHz	
Sync / Shutdown Operating frequency 0.36 0.40 0.44 V Sync / Shutdown Sync Range 320 - 500 kHz Sync Pulse Transition Threshold Rise Time = 20 ns 2.5 - - V SS Bias Current SS = 0V -15 -3 - UA Shutdown Threshold 0.50 0.85 1.20 V Shutdown Delay 2.7V ≤ Vcc ≤ 12V 12 80 350 us Power Switch IswiTCH = 1.5A, Note 2 - 0.8 1.4 V IswiTCH = 1.0A, 0°C ≤ T _A ≤ 70°C - 0.55 1.00 V IswiTCH = 1.0A, 0°C ≤ T _A ≤ 70°C - 0.55 1.00 V IswiTCH = 1.0A, 0°C ≤ T _A ≤ 70°C - 0.55 1.00 V IswiTCH = 1.0A, 0°C ≤ T _A ≤ 70°C - 0.55 1.00 V Switch Current Limit 80% duty cycle, Note 2 1.6 1.9 2.4 A	Maximum Duty Cycle		90	94	_	%	
Sync Range Sync Pulse Transition Threshold Rise Time = 20 ns 2.5 -	FB Frequency Shift Threshold		0.36	0.40	0.44	V	
Sync Pulse Transition Threshold Rise Time = 20 ns 2.5 - - V SS Bias Current SS = 0V -15 -3 - uA Shutdown Threshold 0.50 0.85 1.20 V Shutdown Delay 2.7V ≤ Vcc ≤ 12V 12 80 350 us Power Switch Iswitch = 1.5A, Note 2 - 0.8 1.4 V Iswitch Saturation Voltage Iswitch = 1.5A, Note 2 - 0.8 1.4 V Iswitch Saturation Voltage Iswitch = 1.5A, Note 2 - 0.8 1.4 V Iswitch Saturation Voltage Iswitch = 1.5A, Note 2 - 0.8 1.4 V Iswitch = 1.0A, 0°C ≤ T _A ≤ 70°C - 0.55 1.00 V Switch Current Limit 50% duty cycle, Note 2 1.6 1.9 2.4 A Alice Alice Alice Current Limit FB = 0V, Isw=4.0A, Note 2 2.00 250 300 ns Alice Al	Sync / Shutdown						
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Sync Range		320	-	500	kHz	
SS Bias Current SS = 3.0V - 3 8 UA Shutdown Threshold 0.50 0.85 1.20 V Shutdown Delay 2.7V ≤ Vcc ≤ 12V 12 80 350 us Power Switch I _{SWITCH} = 1.5A, Note 2 - 0.8 1.4 V Switch Saturation Voltage I _{SWITCH} = 1.5A, Note 2 - 0.8 1.4 V Switch Saturation Voltage I _{SWITCH} = 1.0A, 0°C ≤ T _A ≤70°C - 0.55 1.00 V I _{SWITCH} = 1.0A, 0°C ≤ T _A ≤70°C - 0.55 1.00 V Switch Current Limit 50% duty cycle, Note 2 1.6 1.9 2.4 A Minimum Pulse Width FB = 0V, Isw=4.0A, Note 2 1.6 1.9 2.4 A Alcc/Alvsw 1.2 Switch Index - 10 30 mA/A 2.7V≤Vcc≤30V, 10mA≤Isw≤1.0A - - 100 mA/A 2.7V≤Vcc≤3	Sync Pulse Transition Threshold	Rise Time = 20 ns	2.5	-	_	V	
SS = 3.0V	SS Bias Current	SS = 0V	-15	-3	_		
2.7V ≤ Vcc ≤ 12V 12 80 350 us 12V ≤ Vcc ≤ 30V 12 36 200 us 200 us 200 200 us 200		SS = 3.0V	_	3	8	uA	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Shutdown Threshold		0.50	0.85	1.20	V	
Power Switch Iswitch = 1.5A, Note 2 − 0.8 1.4 ∨ Switch Saturation Voltage Iswitch = 1.0A, 0°C ≤ T _A ≤ 70°C − 0.55 1.00 ∨ Iswitch = 10mA − 0.09 0.45 ∨ Switch Current Limit 50% duty cycle, Note 2 1.6 1.9 2.4 A Minimum Pulse Width FB = 0V, Isw=4.0A, Note 2 1.5 1.7 2.2 A Minimum Pulse Width FB = 0V, Isw=4.0A, Note 2 200 250 300 ns 2.7V≤Vcc≤12V, 10mA≤Isw≤1.0A − 10 30 mA/A 12V≤Vcc≤30V, 10mA≤Isw≤1.5A(note2) − 17 30 mA/A 12V≤Vcc≤30V, 10mA≤Isw≤1.5A(note2) − 100 mA/A 12V≤Vcc≤30V, 10mA≤Isw≤1.5A(note2) − 100 mA/A 12V≤Vcc≤30V, 10mA≤Isw≤1.5A(note2) − 100 mA/A 12V≤Vcc≤30V, 10mA≤Isw≤1.5A(note2) − 2.0	Shutdown Delay	2.7V ≤ Vcc ≤ 12V	12	80	350	us	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Shutdown Belay	12V ≤ Vcc ≤ 30V	12	36	200	us	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Power Switch						
			_	0.8	1.4	V	
Switch Current Limit S0% duty cycle, Note 2 1.6 1.9 2.4 A 80% duty cycle, Note 2 1.5 1.7 2.2 A A 80% duty cycle, Note 2 1.5 1.7 2.2 A A S0% duty cycle, Note 2 200 250 300 ns A A A A A A A A A	Switch Saturation Voltage		_	0.55	1.00	V	
		I _{SWITCH} = 10mA	_	0.09	0.45	V	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Switch Current Limit	50% duty cycle, Note 2	1.6	1.9	2.4	Α	
	Switch Guilent Linnt	80% duty cycle, Note 2	1.5	1.7	2.2	Α	
$ \frac{12 \text{V} \le \text{V} \text{cc} \le 30 \text{V}, \ 10 \text{mA} \le \text{Isw} \le 1.0 \text{A}}{2.7 \text{V} \le \text{V} \text{cc} \le 12 \text{V}, 10 \text{mA} \le \text{Isw} \le 1.5 \text{A} (\text{note2})} - 17 30 \text{mA}/\text{A}} $ $ \frac{2.7 \text{V} \le \text{V} \text{cc} \le 12 \text{V}, 10 \text{mA} \le \text{Isw} \le 1.5 \text{A} (\text{note2})}{1.5 \text{A} (\text{note2})} - 17 30 \text{mA}/\text{A}} $ $ \frac{12 \text{V} \le \text{V} \text{cc} \le 30 \text{V}, \ 10 \text{mA} \le \text{Isw} \le 1.5 \text{A} (\text{note2})}{1.5 \text{A} (\text{note2})} - 100 \text{mA}/\text{A}} $ $ \frac{\text{Switch Leakage}}{\text{Switch Leakage}} \frac{\text{Vsw} = 40 \text{V}, \ \text{Vcc} = 0 \text{V}}{1.00 \text{mA}} - 2.0 100 \text{mA}/\text{A}} $ $ \frac{\text{Ceneral}}{\text{Operating Current}} \frac{\text{Isw} = 0}{1.00 \text{mA}} - 2.0 100 \text{mA}/\text{A}} $ $ \frac{\text{Switch Leakage}}{\text{Shutdown mode Current}} \frac{\text{Isw} = 0}{1.00 \text{mA}} - 100 \text{mA}/\text{A} $ $ \frac{\text{Vc} < 0.8 \text{V}, \ \text{SS} = 0 \text{V}, \ 2.7 \text{V} \le \text{Vcc} \le 12 \text{V}}{1.00 \text{mA}} - 100 \text{mA}/\text{A}} $ $ \frac{\text{Vc} < 0.8 \text{V}, \ \text{SS} = 0 \text{V}, \ 2.7 \text{V} \le \text{Vcc} \le 12 \text{V}}{1.00 \text{mA}} - 100 \text{mA}/\text{A}} - 100 \text{mA}/\text{A} $ $ \frac{\text{Vc} < 0.8 \text{V}, \ \text{SS} = 0 \text{V}, \ 2.7 \text{V} \le \text{Vcc} \le 30 \text{V}}{1.00 \text{mA}} - 100 \text{mA}/\text{A} $ $ \frac{\text{Vc} < 0.8 \text{V}, \ \text{SS} = 0 \text{V}, \ 1.2 \text{V} \le \text{Vcc} \le 30 \text{V}}{1.00 \text{mA}} - 100 \text{mA}/\text{A} $ $ \frac{\text{Vc} < 0.8 \text{V}, \ \text{SS} = 0 \text{V}, \ 1.2 \text{V} \le \text{Vcc} \le 30 \text{V}}{1.00 \text{mA}} - 100 \text{mA}/\text{A} $ $ \frac{\text{Vc} < 0.8 \text{V}, \ \text{SS} = 0 \text{V}, \ 1.2 \text{V} \le \text{Vcc} \le 30 \text{V}}{1.00 \text{mA}} - 100 \text{mA}/\text{A} $ $ \frac{\text{Minimum Operating Input Voltage}}{1.00 \text{mA}} - 100 \text{mA}/\text{A} $ $ \frac{\text{Note 2}}{1.00 \text{mA}} - 100 \text{mA}/\text{A} $	Minimum Pulse Width	FB = 0V, Isw=4.0A, Note 2	200	250	300	ns	
		2.7V≤Vcc≤12V, 10mA≤lsw≤1.0A	_	10	30	mA/A	
	Alec/Alvew	12V≤Vcc≤30V, 10mA≤lsw≤1.0A	_	_	100	mA/A	
	ΔICC/ΔIVSW	2.7V≤Vcc≤12V,10mA≤lsw≤1.5A(note2)	_	17	30	mA/A	
		12V≤Vcc≤30V, 10mA≤lsw≤1.5A(note2)	_	_	100	mA/A	
	Switch Leakage	Vsw = 40V, Vcc = 0V	_	2.0	100	uA	
	General						
Shutdown mode Current Vc<0.8V, SS=0V, 2.7V≤Vcc≤12V - 12 60 uA Vc<0.8V, SS=0V, 12V≤Vcc≤30V		Isw = 0	-	5.5	8	mA	
Shutdown mode Current Vc<0.8V, SS=0V, 12V≤Vcc≤30V	Shutdown mode Current		_		60		
Minimum Operating Input VoltageVsw Switching, Maximum Isw=10mA−2.452.70VThermal ShutdownNote 2150180210℃			_	-			
Thermal Shutdown Note 2 150 180 210 °C	Minimum Operating Input Voltage		_	2.45			
			150			${\mathbb C}$	
	Thermal Hysteresis						

Note 2: Guaranteed by design, not 100% tested in production.

TYPICAL PERFORMANCE CHARACTERISTICS

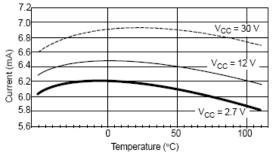


Figure 3. I_{CC} (No Switching) vs. Temperature

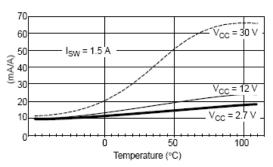


Figure 4. $\Delta I_{CC} / \Delta IV_{SW}$ vs. Temperature

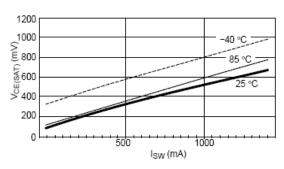


Figure 5. V_{CE(SAT)} vs. Isw

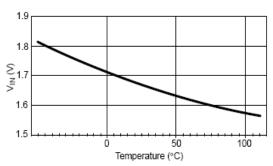


Figure 6. Minimum Input Voltage vs. Temperature

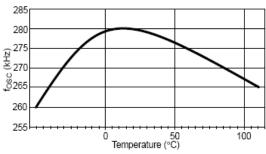


Figure 7. Switching Frequency vs. Temperature

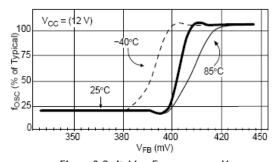


Figure 8. Switching Frequency vs. V_{FB}

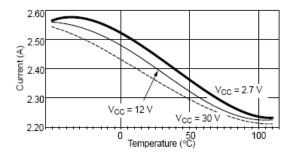


Figure 9. Current Limit vs. Temperature

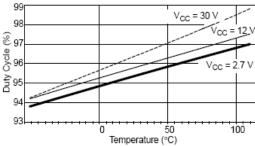


Figure 10. Maximum Duty Cycle vs. Temperature

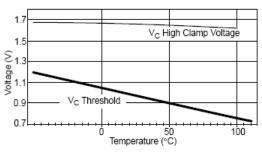


Figure 11. V_C Threshold and High Clamp Voltage vs. Temperature

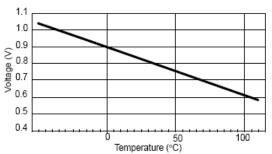


Figure 12. Shutdown Threshold vs. Temperature

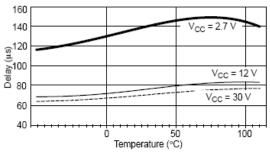


Figure 13. Shutdown Delay vs. Temperature

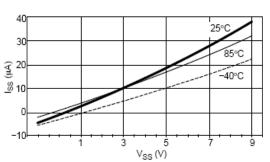


Figure 14. Iss vs. Vss

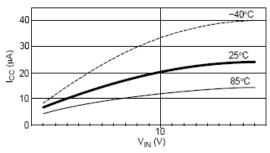


Figure 15. I_{CC} vs. V_{IN} During Shutdown

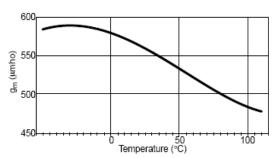


Figure 16. Error Amplifier Transconductance vs. Temperature

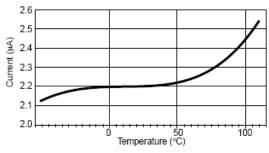


Figure 17. Switch Leakage vs. Temperature

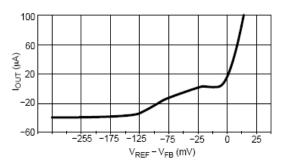


Figure 18. Error Amplifier I_{OUT} vs. V_{FB}

THEORY of OPERATION: Current Mode Control

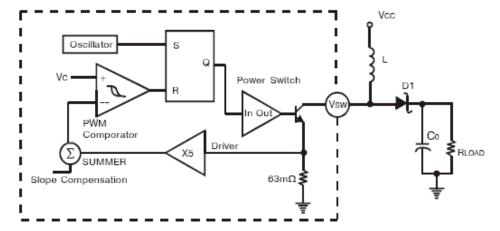


Figure 19. Current Mode Control Scheme

The LM5171 is a current mode control scheme, in which the PWM ramp signal is derived from the power switch current. This ramp signal is compared to the output of the error amplifier to control the on-time of the power switch. The oscillator is used as a fixed-frequency clock to ensure a constant operational frequency. The resulting control scheme features several advantages over conventional voltage mode control. First, derived directly from the inductor, the ramp signal responds immediately to line voltage changes. This eliminates the delay caused by the output filter and error amplifier, which is commonly found in voltage mode controllers. The second benefit comes from inherent pulse-by-pulse current limiting by merely clamping the peak switching current. Finally, since current mode commands an output current rather than voltage, the filter offers only a single pole to the feedback loop. This allows both a simpler compensation and a higher gain-bandwidth over a comparable voltage mode circuit.

Without discrediting its apparent merits, current mode control comes with its own peculiar problems, mainly, sub-harmonic oscillation at duty cycles over 50%. The LM5171 solves this problem by adopting a slope compensation scheme in which a fixed ramp generated by the oscillator is added to the current ramp. A proper slope rate is provided to improve circuit stability without sacrificing the advantages of current mode control.

Oscillator and Shutdown

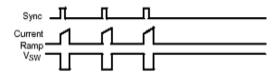


Figure 20. Timing Diagram of Sync and Shutdown

The oscillator is trimmed to guarantee an 18% frequency accuracy. The output of the oscillator turns on the power switch at a frequency of 280 kHz, as shown in Figure 1. The power switch is turned off by the output of the PWM Comparator.

A TTL-compatible sync input at the SS pin is capable of syncing up to 1.8 times the base oscillator frequency. As shown in Figure 2, in order to sync to a higher frequency, a positive transition turns on the power switch before the output of the oscillator goes high, thereby resetting the oscillator. The sync operation allows multiple power supplies to operate at the same frequency.

A sustained logic low at the SS pin will shut down the IC and reduce the supply current.

An additional feature includes frequency shift to 20% of the nominal frequency when the FB pin trigger the threshold. During power up, overload, or short circuit conditions, the minimum switch on–time is limited by the PWM comparator minimum pulse width. Extra switch off–time reduces the minimum duty cycle to protect external components and the IC itself.

As previously mentioned, this block also produces a ramp for the slope compensation to improve regulator stability.

Error Amplifier

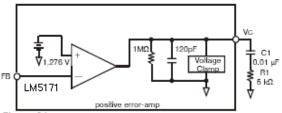


Figure 21. Error Amplifier Equivalent Circuit

The FB pin is directly connected to the inverting input of the positive error amplifier, whose non–inverting input is fed by the 1.276 V reference. The amplifier is transconductance amplifier with a high output impedance of approximately 1 M Ω , as shown in Figure 3. The V $_{\rm C}$ pin is connected to the output of the error amplifiers and is internally clamped between 0.5 V and 1.7 V. A typical connection at the V $_{\rm C}$ pin includes a capacitor in series with a resistor to ground, forming a pole/zero for loop compensation.

An external shunt can be connected between the V_{C} pin and ground to reduce its clamp voltage.

Consequently, the current limit of the internal power transistor current is reduced from its nominal value.

Switch Driver and Power Switch

The switch driver receives a control signal from the logic section to drive the output power switch. The switch is grounded through emitter resistors (63 m Ω total) to the PGND pin. PGND is not connected to the IC substrate so that switching noise can be isolated from the analog ground. The peak switching current is clamped by an internal circuit. The clamp current is guaranteed to be greater than 1.5 A and varies with duty cycle due to slope compensation. The power switch can withstand a maximum voltage of 40 V on the collector (Vsw pin). The saturation voltage of the switch is typically less than 1 V to minimize power dissipation.

Short Circuit Condition

When a short circuit condition happens in a boost circuit, the inductor current will increase during the whole switching cycle, causing excessive current to be drawn from the input power supply. Since control ICs don't have the means to limit load current, an external current limit circuit such as a fuse or relay) has to be implemented to protect the load, power supply and ICs.

In other topologies, the frequency shift built into the IC prevents damage to the chip and external components. This feature reduces the minimum duty cycle and allows the transformer secondary to absorb excess energy before the switch turns back on.

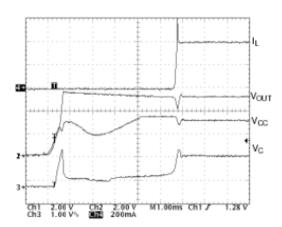


Figure 22. Startup Waveforms of Circuit Shown in the Application Diagram.

Load = 400 mA.

The LM5171 can be activated by either connecting the V_{CC} pin to a voltage source or by enabling the SS pin. Startup waveforms shown in Figure 4 are measured in the boost converter demonstrated in the Application Diagram on the page 1 of this document. Recorded after the input voltage is turned on, this waveform shows the various phases during the power up transition.

When the $V_{\rm CC}$ voltage is below the minimum supply voltage, the $V_{\rm SW}$ pin is in high impedance. Therefore, current conducts directly from the input power source to the output through the inductor and diode. Once $V_{\rm CC}$ reaches approximately 1.5 V, the internal power switch briefly turns on. This is a part of the LM5171 normal operation. The turn-on of the power switch accounts for the initial current swing.

When the V_c pin voltage rises above the threshold, the internal power switch starts to switch and a voltage pulse can be seen at the V_{SW} pin. Detecting a low output voltage at the FB pin, the built-in frequency shift feature reduces the switching frequency to a fraction of its nominal

value, reducing the minimum duty cycle, which is otherwise limited by the minimum on-time of the switch. The peak current during this phase is clamped by the internal current limit.

When the FB pin voltage rises above 0.4 V, the frequency increases to its nominal value, and the peak current begins to decrease as the output approaches the regulation voltage. The overshoot of the output voltage is prevented by the active pull—on, by which the sink current of the error amplifier is increased once an overvoltage condition is detected. The overvoltage condition is defined as when the FB pin voltage is 50 mV greater than the reference voltage.

COMPONENT SELECTION

Frequency Compensation

The goal of frequency compensation is to achieve desirable transient response and DC regulation while ensuring the stability of the system. A typical compensation network, as shown in Figure 5, provides a frequency response of two poles and one zero. This frequency response is further illustrated in the Bode plot shown in Figure 6.

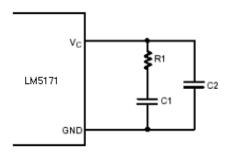


Figure 23. A Typical Compensation Network

The high DC gain in Figure 6 is desirable for achieving DC accuracy over line and load variations. The DC gain of a transconductance error amplifier can be calculated as follows:

$$Gain_{DC} = G_M \times R_0$$

where:

G_M = error amplifier transconductance;

R₀ =error amplifier output resistance ≈1MΩ.

The low frequency pole, f_{P1}, is determined by the error amplifier output resistance and C1 as:

$$f_{P1} = \frac{1}{2\pi C 1 R_0}$$

The first zero generated by C1 and R1 is:

$$f_{z1} = \frac{1}{2\pi C1R1}$$

The phase lead provided by this zero ensures that the loop has at least a 45° phase margin at the crossover frequency. Therefore, this zero should be placed close to the pole generated in the power stage which can be identified at frequency:

$$f_P = \frac{1}{2\pi C_0 R_{LOAD}}$$

where:

C₀ = equivalent output capacitance of the error amplifier ≈120pF;

R_{LOAD}= load resistance.

The high frequency pole, f_{P2}, can be placed at the output filter's ESR zero or at half the switching

frequency. Placing the pole at this frequency will cut down on switching noise. The frequency of this pole is determined by the value of C2 and R1:

$$f_{P2} = \frac{1}{2\pi C 2R1}$$

One simple method to ensure adequate phase margin is to design the frequency response with a -20 dB per decade slope, until unity–gain crossover. The crossover frequency should be selected at the midpoint between f_{z_1} and f_{z_2} where the phase margin is maximized.

Frequency (LOG)

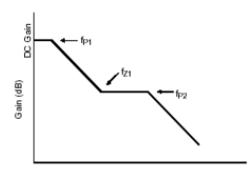


Figure 24. Bode Plot of the Compensation Network Shown in Figure 23.

V_{SW} Voltage Limit

In the boost topology, $V_{\rm SW}$ pin maximum voltage is set by the maximum output voltage plus the output diode forward voltage. The diode forward voltage is typically 0.5V for Schottky diodes and 0.8V for ultrafast recovery diodes

where:

V_F = output diode forward voltage.

In the flyback topology, peak VSW voltage is governed by:

$$V_{SW(MAX)} = V_{CC(MAX)} + (VOUT + V_F)XN$$

where:

N = transformer turns ratio, primary over secondary.

When the power switch turns off, there exists a voltage spike superimposed on top of the steady-state voltage. Usually this voltage spike is caused by transformer leakage inductance charging stray capacitance between the V_{SW} and PGND pins. To prevent the voltage at the V_{SW} pin from exceeding the maximum rating, a transient voltage suppressor in series with a diode is paralleled with the primary windings. Another method of clamping switch voltage is to connect a transient voltage suppressor between the V_{SW} pin and ground.

Magnetic Component Selection

When choosing a magnetic component, one must consider factors such as peak current, core and ferrite material, output voltage ripple, EMI, temperature range, physical size and cost. In boost circuits, the average inductor current is the product of output current and voltage gain (Vout/Vcc), assuming 100% energy transfer efficiency. In continuous conduction mode, inductor ripple current is

$$I_{\textit{RIPPLE}} = \frac{V_{\textit{CC}}(V_{\textit{OUT}} - V_{\textit{CC}})}{(f)(L)(V_{\textit{OUT}})}$$

where:

f=280 kHz.

The peak inductor current is equal to average current plus half of the ripple current, which should

not cause inductor saturation. The above equation can also be referenced when selecting the value of the inductor based on the tolerance of the ripple current in the circuits. Small ripple current provides the benefits of small input capacitors and greater output current capability. A core geometry like a rod or barrel is prone to generating high magnetic field radiation, but is relatively cheap and small. Other core geometries, such as toroids, provide a closed magnetic loop to prevent EMI.

Input Capacitor Selection

In boost circuits, the inductor becomes part of the input filter, as shown in Figure 26. In continuous mode, the input current waveform is triangular and does not contain a large pulsed current, as shown in Figure 25. This reduces the requirements imposed on the input capacitor selection. During continuous conduction mode, the peak to peak inductor ripple current is given in the previous section. As we can see from Figure 25 the product of the inductor current ripple and the input capacitor's effective series resistance (ESR) determine the $V_{\rm CC}$ ripple. In most applications, input capacitors in the range of 10 $\mu \rm F$ to 100 $\mu \rm F$ with an ESR less than 0.3 Ω work well up to a full 1.5 A switch current.

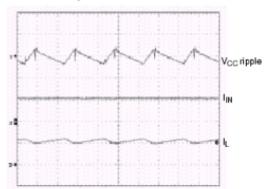


Figure 25. Boost Input Voltage and Current Ripple Waveforms

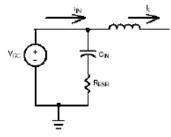


Figure 26. Boost Circuit Effective Input Filter

The situation is different in a flyback circuit. The input current is discontinuous and a significant pulsed current is seen by the input capacitors. Therefore, there are two requirements for capacitors in a flyback regulator: energy storage and filtering. To maintain a stable voltage supply to the chip, a storage capacitor larger than 20 μF with low ESR is required. To reduce the noise generated by the inductor, insert a 1.0 μF ceramic capacitor between V_{CC} and ground as close as possible to the chip.

By examining the waveforms shown in Figure 9, we can see that the output voltage ripple comes from two major sources, namely capacitor ESR and the charging/discharging of the output capacitor. In boost circuits, when the power switch turns off, I_L flows into the output capacitor causing an instant $\Delta V = I_{IN} \times ESR$. At the same time, current $I_L - I_{OUT}$ charges the capacitor and increases the output voltage

gradually.

Output Capacitor Selection



Figure 27, Typical Output Voltage Ripple

$$V_{OUT(RIPPLE)} = \frac{(I_{I\!N} - I_{OUT})(1-D)}{(C_{OUT})(f)} + \frac{I_{OUT}D}{(C_{OUT})(f)} + I_{I\!N} \times ESR$$
 The equation can be expressed more conveniently in terms of \lor_{CC} , \lor_{Out} and I_{Out} for design purposes as follows:

The equation can be expressed more conveniently in terms of
$$\forall_{\text{Co.}}, \forall_{\text{Out}}$$
 and I_{OUT} for design purp
$$V_{OUT(\textit{RIPPLE})} = \frac{I_{OUT}(V_{OUT} - V_{CC})}{(C_{OUT})(f)} \times \frac{1}{(C_{OUT})(f)} + \frac{(I_{OUT})(V_{OUT})(ESR)}{V_{CC}}$$
 The capacitor RMS ripple current is:

$$I_{\it RIPPLE} = \sqrt{{(I_{\it IN} - I_{\it OUT})}^2 (1 - D) + {(I_{\it OUT})}^2 (D)} = I_{\it OUT} \sqrt{\frac{V_{\it OUT} - V_{\it CC}}{V_{\it CC}}}$$

Although the above equations apply only for boost circuits, similar equations can be derived for flyback circuits.

Reducing the Current Limit

In some applications, the designer may prefer a lower limit on the switch current than 1.5 A. An external shunt can be connected between the Vc pin and ground to reduce its clamp voltage. Consequently, the current limit of the internal power transistor current is reduced from its nominal value.

The voltage on the Vc pin can be evaluated with the equation

where:

 $R_E = 0.063\Omega$, the value of the internal emitter resistor; A_V=5 V/V, the gain of the current sense amplifier.

Since Re and Av cannot be changed by the end user, the only available method for limiting switch current below 1.5 A is to clamp the Vc pin at a lower voltage. If the maximum switch or inductor current is substituted into the equation above, the desired clamp voltage will result.

A simple diode clamp, as shown in Figure 28, clamps the Vc voltage to a diode drop above the voltage on resistor R3. Unfortunately, such a simple circuit is not generally acceptable if V_{IN} is loosely regulated.

Another solution to the current limiting problem is to externally measure the current through the switch using a sense resistor. Such a circuit is illustrated in Figure 29.

The switch current is limited to

$$I_{\mathit{SWITCH(PEAK)}} = \frac{V_{\mathit{BE(Q1)}}}{R_{\mathit{SENSE}}}$$

V_{BE(Q1)}=the base-emitter voltage drop of Q1, typically 0.65V.

When the power switch is turned on, I is shunted to ground and Iout discharges the output capacitor. When the I ripple is small enough, IL can be treated as a constant and is equal to input current I_{IN}. Summing up, the output voltage peak-peak ripple can be calculated by:

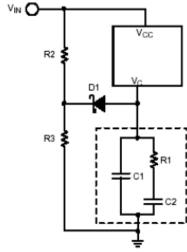


Figure 28. Current Limiting using a Diode Clamp

The improved circuit does not require a regulated voltage to operate properly. Unfortunately, a price must be paid for this convenience in the overall efficiency of the circuit. The designer should note that the input and output grounds are no longer common. Also, the addition of the current sense resistor, R_{SENSE}, results in a considerable power loss which increases with the duty cycle. Resistor R2 and capacitor C3 form a low-pass filter to remove noise.

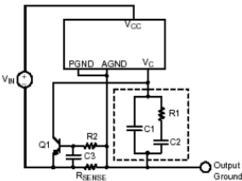


Figure 29. Current Limiting using a Current Sense Resistor

Subharmonic Oscillation

Subharmonic oscillation (SHM) is a problem found in current-mode control systems, where instability results when duty cycle exceeds 50%. SHM only occurs in switching regulators with a continuous inductor current. This instability is not harmful to the converter and usually does not affect the output voltage regulation. SHM will increase the radiated EM noise from the converter and can cause, under certain circumstances, the inductor to emit high-frequency audible noise.

SHM is an easily remedied problem. The rising slope of the inductor current is supplemented with internal "slope compensation" to prevent any duty cycle instability from carrying through to the next switching cycle. In the LM5171, slope compensation is added during the entire switch ontime, typically in the amount of 180 mA/µs.

In some cases, SHM can rear its ugly head despite the presence of the onboard slope compensation. The simple cure to this problem is more slope compensation to avoid the unwanted oscillation. In that case, an external circuit, shown in Figure 40, can be added to increase the amount of slope compensation used. This circuit requires only a few components and is "tacked on" to the compensation network.

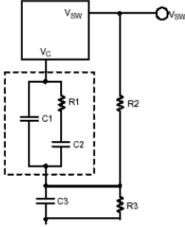


Figure 30. Technique for Increasing Slope Compensation

The dashed box contains the normal compensation circuitry to limit the bandwidth of the error amplifier. Resistors R2 and R3 form a voltage divider off of the V_{SW} pin. In normal operation, V_{SW} looks similar to a square wave, and is dependent on the converter topology. Formulas for calculating V_{SW} in the boost and flyback topologies are given in the section " V_{SW} Voltage Limit." The voltage on V_{SW}

charges capacitor C3 when the switch is off, causing the voltage at the $V_{\rm C}$ pin to shift upwards. When the switch turns on, C3 discharges through R3, producing a negative slope at the $V_{\rm C}$ pin. This negative slope provides the slope compensation.

The amount of slope compensation added by this circuit is

$$\frac{\Delta I}{\Delta T} = V_{SW} \left(\frac{R_3}{R_2 + R_3} \right) \left(1 - e^{\frac{-(1 - D)}{R_3 C_3 f_{SW}}} \right) \left(\frac{f_{SW}}{(1 - D) R_E A_V} \right)$$

where:

 $\Delta I/\Delta T$ = the amount of slope compensation added (A/s); V_{SW} = the voltage at the switch node when the transistor is turned off (V);

f_{sw} = the switching frequency, typically 280 kHz; D = the duty cycle;

 R_{E} = 0.063 $\Omega,$ the value of the internal emitter resistor;

A_V = 5 V/V, the gain of the current sense amplifier.

In selecting appropriate values for the slope compensation network, the designer is advised to choose a convenient capacitor, then select values for R2 and R3 such that the amount of slope compensation added is 100 mA/ μ s. Then R2 may be increased or decreased as necessary. Of course, the series combination of R2 and R3 should be large enough to avoid drawing excessive current from V_{SW}. Additionally, to ensure that the control loop stability is *improved*, the time constant formed by the additional components should be chosen such that

$$R_3C_3\langle \frac{1-D}{f_{sw}}$$

Finally, it is worth mentioning that the added slope compensation is a trade-off between duty cycle stability and transient response. The more slope compensation a designer adds, the slower the transient response will be, due to the external circuitry interfering with the proper operation of the error amplifier.

Soft Start

Through the addition of an external circuit, a soft-start function can be added to the CS5171. Soft-start circuitry prevents the $V_{\rm C}$ pin from slamming high during startup, thereby inhibiting the inductor current from rising at a high slope.

This circuit, shown in Figure 13, requires a minimum number of components and allows the soft-start circuitry to activate any time the SS pin is used to restart the converter.

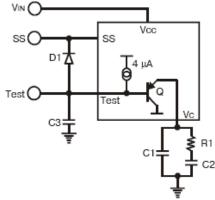


Figure 31. Soft Start

Resistor R1 and capacitors C1 and C2 form the compensation network. At turn on, the voltage at the Vc pin starts to come up, charging capacitor C3 through transistor Q, clamping the voltage at the Vo pin such that switching begins when Vc reaches the VC threshold, typically 1.05 V.

Therefore, C3 slows the startup of the circuit by limiting the voltage on the Vc pin. The soft-start time increases with the size of C3.

Diode D1 discharges C3 when SS is low. If the shutdown function is not used with this part, the cathode of D1 should be connected to VIN-

Calculating Junction Temperature

To ensure safe operation of the LM5171, the designer must calculate the on-chip power dissipation and determine its expected junction temperature. Internal thermal protection circuitry will turn the part off once the junction temperature exceeds 180°C±30°. However, repeated operation at such high temperatures will ensure a reduced operating life.

Calculation of the junction temperature is an imprecise but simple task. First, the power losses must be quantified. There are three major sources of power loss on the LM5171:

- biasing of internal control circuitry, PBIAS
- switch driver, PDRIVER
- switch saturation, P_{SAT}

The internal control circuitry, including the oscillator and linear regulator, requires a small amount of power even when the switch is turned off. The specifications section of this datasheet reveals that the typical operating current, Iq, due to this circuitry is 5.5mA. Additional guidance can be found in the graph of operating current vs. temperature. This graph shows that I is strongly dependent on input voltage, V_{IN}, and the ambient temperature, T_A. Then

Since the onboard switch is an NPN transistor, the base drive current must be factored in as well. This current is drawn from the VIN pin, in addition to the control circuitry current. The base drive current is listed in the specifications as Δl_{co}/Δl_{sw}, or switch transconductance. As before, the designer will find additional guidance in the graphs. With that information, the designer can calculate

$$P_{\mathit{DRIVER}} = V_{\mathit{IN}} I_{\mathit{SW}} \times \frac{I_{\mathit{CC}}}{\Delta I_{\mathit{SW}}} \times D$$

where:

Isw=the current through the switch;

D=the duty cycle or percentage of switch on-time.

I_{sw} and D are dependent on the type of converter. In a boost converter,

$$I_{\mathit{SW}(\mathit{AVG})} \cong I_{\mathit{LOAD}} \times D \times \frac{1}{\mathit{Efficiency}}$$

$$D \cong \frac{V_{OUT} - V_{IN}}{V_{OUT}}$$

In a flyback converter

$$I_{\mathit{SW}(\mathit{AVG})} \cong \frac{V_{\mathit{OUT}}I_{\mathit{LOAD}}}{V_{\mathit{IN}}} \times \frac{1}{\mathit{Efficiency}}$$

$$D \cong \frac{V_{OUT}}{V_{OUT} + \frac{N_{S}}{N_{P}}V_{IN}}$$

The switch saturation voltage, $V_{(CE)SAT}$, is the last major source of on-chip power loss. $V_{(CE)SAT}$ is the collectoremitter voltage of the internal NPN transistor when it is driven into saturation by its base drive current. The value for V_{(CE)SAT} can be obtained from the specifications or from the graphs, as "Switch Saturation Voltage." Thus,

$$P_{\mathit{SAT}} \cong V_{(\mathit{CE})\,\mathit{SAT}} I_{\mathit{SW}} \times D$$
 Finally, the total on–chip power losses are

$$P_D = P_{BLAS} + P_{DRIVER} + P_{SAT}$$

Power dissipation in a semiconductor device results in the generation of heat in the junctions at the surface of the chip. This heat is transferred to the surface of the IC package, but a thermal gradient exists due to the resistive properties of the package molding compound. The magnitude of the thermal gradient is expressed in manufacturers' data sheets as Θ_{JA} , or junction-to-ambient thermal resistance. The on-chip junction temperature can be calculated if OJA, the air temperature near the surface of the IC, and the onchip power dissipation are known.

$$T_J = T_J + (P_D \Theta_{JJ})$$

where:

T_J = IC or FET junction temperature (°C);

 T_A = ambient temperature (°C);

PD = power dissipated by part in question (W);

Θ_{JA} = junction-to-ambient thermal resistance (°C/W). For the LM5171 Θ_{JA}=165°C/W.

Once the designer has calculated T_J, the question whether the LM5171 can be used in an application is settled. If T_J exceeds 150°C, the absolute maximum allowable junction temperature, the LM5171 is not suitable for that applica-

If T_J approaches 150°C, the designer should consider possible means of reducing the junction temperature. Perhaps another converter topology could be selected reduce the switch current. Increasing the airflow across the surface of the chip might be considered to reduce T_A.

Circuit Layout Guidelines

In any switching power supply, circuit layout is very important for proper operation. Rapidly switching currents combined with trace inductance generates voltage transitions that can cause problems. Therefore the following guidelines should be followed in the layout.

- In boost circuits, high AC current circulates within the loop composed of the diode, output capacitor, and on-chip power transistor. The length of associated traces and leads should be kept as short as possible. In the flyback circuit, high AC current loops exist on both sides of the transformer. On the primary side, the loop consists of the input capacitor, transformer, and on-chip power transistor, while the transformer, rectifier diodes, and output capacitors form another loop on the secondary side. Just as in the boost circuit, all traces and leads containing large AC currents should be kept
- 2. Separate the low current signal grounds from the power grounds. Use single point grounding or ground plane construction for the best results.
- 3. Locate the voltage feedback resistors as near the IC as possible to keep the sensitive feedback wiring short. Connect feedback resistors to the low current analog ground.